SLVS011D - OCTOBER 1982 - REVISED AUGUST 2003

- 3-Terminal Regulators
- Output Current Up To 100 mA
- No External Components Required
- Internal Thermal-Overload Protection
- Internal Short-Circuit Current Limiting
- Direct Replacement for Industry-Standard MC79L00 Series
- Available in 5% or 10% Selections

description/ordering information

This series of fixed negative-voltage integrated-circuit voltage regulators is designed for a wide range of applications. These include on-card regulation for elimination of noise and distribution problems associated with single-point



[†] Internally connected NC – No internal connection



regulation. In addition, they can be used to control series pass elements to make high-current voltage-regulator circuits. One of these regulators can deliver up to 100 mA of output current. The internal current-limiting and thermal-shutdown features essentially make the regulators immune to overload. When used as a replacement for a Zener-diode and resistor combination, these devices can provide an effective improvement in output impedance of two orders of magnitude, with lower bias current.

Тj	OUTPUT VOLTAGE TOLERANCE	NOMINAL OUTPUT VOLTAGE (V)	PACKAGE [†]		ORDERABLE PART NUMBER	TOP-SIDE MARKING	
		-5	SOIC (D)	Tube of 75	MC79L05ACD	79L05A	
	5%		50IC (D)	Reel of 2500	MC79L05ACDR		
				Bulk of 1000	MC79L05ACLP	701.054.0	
			10-2267 10-92 (LP)	Reel of 2000	MC79L05ACLPR	1 SLUSAC	
		-12	SOIC (D)	Tube of 75	MC79L12ACD	79L12A	
			301C (D)	Reel of 2500	MC79L12ACDR		
0°C to 125°C			TO-226 / TO-92 (LP)	Bulk of 1000	MC79L12ACLP	701 124 C	
				Reel of 2000	MC79L12ACLPR	79L1ZAC	
				Bulk of 1000	MC79L15ACLP	79L15AC	
		-15	TO-226 / TO-92 (LP)	Ammo of 2000	MC79L15ACLPM		
				Reel of 2000	MC79L15ACLPR		
	1.09/	-12	TO-226 / TO-92 (LP)	Bulk of 1000	MC79L12CLP	79L12C	
	10%	-15	SOIC (D)	Tube of 75	MC79L15CD	79L15C	

ORDERING INFORMATION

[†] Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.



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equivalent schematic



absolute maximum ratings over operating free-air temperature range (unless otherwise noted)[†]

Input voltage: MC79L05	
MC79L12, MC79L15	–35 V
Package thermal impedance, θ_{JA} (see Notes 1 and 2): D package	
LP package	e 140°C/W
Operating free-air, case, or virtual junction temperature	150°C
Lead temperature 1.6 mm (1/16 inch) from case for 10 seconds	
Storage temperature range, T _{stg}	

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. Maximum power dissipation is a function of $T_J(max)$, θ_{JA} , and T_A . The maximum allowable power dissipation at any allowable ambient temperature is $P_D = (T_J(max) - T_A)/\theta_{JA}$. Operating at the absolute maximum T_J of 150°C can affect reliability.

2. The package thermal impedance is calculated in accordance with JESD 51-7.

recommended operating conditions

		-	MIN	MAX	UNIT
		MC79L05	-7	-20	
VI	Input voltage	MC79L12	-14.5	-27	V
		MC79L15	-17.5	-30	
IO	Output current			100	mA
Тј	0	125	°C		



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DADAMETED	TEST CONDITIONS [†]	Τ.	MC79L05C			MC79L05AC			LINUT
PARAMETER		IJ	MIN	TYP	MAX	MIN	TYP	MAX	
Output voltage‡		25°C	-4.6	-5	-5.4	-4.8	-5	-5.2	
	$V_I = -7 V$ to $-20 V$, I _O = 1 mA to 40 mA	0°C to 125°C	-4.5		-5.5	-4.75		-5.25	V
	$V_{I} = -10 V$, $I_{O} = 1 mA$ to 70 mA	0°C to 125°C	-4.5		-5.5	-4.75		-5.25	
	$V_{I} = -7 V \text{ to } -20 V$	25°C			200			150	mV
input regulation	$V_I = -8 V \text{ to } -20 V$				150			100	
Ripple rejection	$V_{I} = -8 V \text{ to } -18 V, f = 120 \text{ Hz}$	25°C	40	49		41	49		dB
	I _O = 1 mA to 100 mA	0500			60			60	mV
	$I_{O} = 1 \text{ mA to } 40 \text{ mA}$	25°C			30			30	
Output noise voltage	f = 10 Hz to 100 kHz	25°C		40			40		μV
Dropout voltage	I _O = 40 mA	25°C		1.7			1.7		V
Dice ourrent		25°C			6			6	~ ^
Dias current		125°C			5.5			5.5	1 mA
Discourse (alter	$V_{I} = -8 V \text{ to } -20 V$				1.5			1.5	mA
bias current change	$I_{O} = 1 \text{ mA to } 40 \text{ mA}$				0.2			0.1	

electrical characteristics at specified virtual junction temperature, $V_I = -10 V$, $I_O = 40 mA$ (unless otherwise noted)

[†] All characteristics are measured with a 0.33-μF capacitor across the input and a 0.1-μF capacitor across the output. Pulse-testing techniques are used to maintain the junction temperature as close to the ambient temperature as possible. Thermal effects must be taken into account separately.
[‡] This specification applies only for dc power dissipation permitted by absolute maximum ratings.

electrical characteristics at specified virtual junction temperature, $V_I = -19 V$, $I_O = 40 mA$ (unless otherwise noted)

DADAMETED	TEST CONDITIONS	TJ	MC79L12C			MC79L12AC				
PARAMETER	TEST CONDITIONS		MIN	TYP	MAX	MIN	TYP	MAX	UNIT	
		25°C	-11.1	-12	-12.9	-11.5	-12	-12.5		
Output voltage‡	$V_{I} = -14.5 V \text{ to } -27 V,$ I _O = 1 mA to 40 mA	0°C to 125°C	-10.8		-13.2	-11.4		-12.6	V	
	$V_{I} = -19 V$, $I_{O} = 1 mA$ to 70 mA	0°C to 125°C	-10.8		-13.2	-11.4		-12.6		
	$V_{I} = -14.5 V \text{ to } -27 V$	25°C			250			250	m)/	
Input regulation	$V_{I} = -16 \text{ V to } -27 \text{ V}$				200			200	IIIV	
Ripple rejection	$V_{I} = -15 V$ to $-25 V$, f = 120 Hz	25°C	36	42		37	42		dB	
	$I_{O} = 1 \text{ mA to } 100 \text{ mA}$	25°C			100			100	mV	
	$I_{O} = 1 \text{ mA to } 40 \text{ mA}$				50			50		
Output noise voltage	f = 10 Hz to 100 kHz	25°C		80			80		μV	
Dropout voltage	I _O = 40 mA	25°C		1.7			1.7		V	
Diag ourrent		25°C			6.5			6.5	~^^	
bias current		125°C			6			6	ma	
Diag ourrent change	$V_{I} = -16 \text{ V to } -27 \text{ V}$	0°C to 125°C			1.5			1.5		
Bias current change	$I_{O} = 1 \text{ mA to } 40 \text{ mA}$				0.2			0.1	- mA	

[†] All characteristics are measured with a $0.33 - \mu$ F capacitor across the input and a $0.1 - \mu$ F capacitor across the output. Pulse-testing techniques are used to maintain the junction temperature as close to the ambient temperature as possible. Thermal effects must be taken into account separately.

[‡] This specification applies only for dc power dissipation permitted by absolute maximum ratings.



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electrical characteristics at specified virtual junction temperature, $V_I = -23 V$, $I_O = 40 mA$ (unless otherwise noted)

DADAMETED	TEST CONDITIONS [†]	τ.	MC79L15C			MC79L15AC				
PARAMETER		'J	MIN	TYP	MAX	MIN	TYP	MAX	UNIT	
Output voltage‡		25°C	-13.8	-15	-16.2	-14.4	-15	-15.6		
	$V_I = -17.5 V \text{ to } -30 V,$ $I_O = 1 \text{ mA to } 40 \text{ mA}$	0°C to 125°C	-13.5		-16.5	-14.25		-15.75	V	
	$V_{I} = -23 \text{ V}, I_{O} = 1 \text{ mA to } 70 \text{ mA}$	0°C to 125°C	-13.5		-16.5	-14.25		-15.75		
	$V_{I} = -17.5 \text{ V to } -30 \text{ V}$	25°C			300			300		
input regulation	$V_{I} = -17.5 \text{ V to } -30 \text{ V}$				250			250		
Ripple rejection	$V_{I} = -18.5 V$ to $-28.5 V$, f = 120 Hz	25°C	33	39		34	39		dB	
	I _O = 1 mA to 100 mA	25°C			150			150	m\/	
Output regulation	$I_{O} = 1 \text{ mA to } 40 \text{ mA}$				75			75	IIIV	
Output noise voltage	f = 10 Hz to 100 kHz	25°C		90			90		μV	
Dropout voltage	I _O = 40 mA	25°C		1.7			1.7		V	
Bias current		25°C			6.5			6.5	m (
		125°C			6			6	IIIA	
Dias ourrept change	$V_{I} = -20 V \text{ to } -30 V$	0°C to 125°C			1.5			1.5	m۸	
bias current change	$I_{O} = 1 \text{ mA to } 40 \text{ mA}$	0 0 10 125 0			0.2			0.1	mA	

[†] All characteristics are measured with a 0.33-μF capacitor across the input and a 0.1-μF capacitor across the output. Pulse-testing techniques are used to maintain the junction temperature as close to the ambient temperature as possible. Thermal effects must be taken into account separately.
[‡] This specification applies only for dc power dissipation permitted by absolute maximum ratings.



D (R-PDSO-G8)

PLASTIC SMALL-OUTLINE PACKAGE



NOTES: A. All linear dimensions are in inches (millimeters).

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).

D. Falls within JEDEC MS-012 variation AA.



MECHANICAL DATA

MSOT002A - OCTOBER 1994 - REVISED NOVEMBER 2001

LP (O-PBCY-W3)

PLASTIC CYLINDRICAL PACKAGE



NOTES: A. All linear dimensions are in inches (millimeters).

B. This drawing is subject to change without notice.

 \underline{c} Lead dimensions are not controlled within this area

D. FAlls within JEDEC TO -226 Variation AA (TO-226 replaces TO-92)

E. Shipping Method:

Straight lead option available in bulk pack only.

Formed lead option available in tape & reel or ammo pack.

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LP (O-PBCY-W3)

PLASTIC CYLINDRICAL PACKAGE



NOTES: A. All linear dimensions are in inches (millimeters).

B. This drawing is subject to change without notice.

C. Tape and Reel information for the Format Lead Option package.



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Mailing Address:

Texas Instruments

Post Office Box 655303 Dallas, Texas 75265

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